

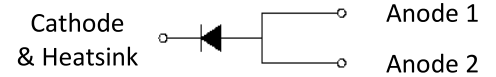
SCHOTTKY BARRIER RECTIFIER

FEATURES

- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
 - Metal silicon junction ,majority carrier conduction
 - Guard ring for overvoltage protection
 - Low power loss ,high efficiency
 - High current capability ,low forward voltage drop
 - High surge capability
 - Very low profile-typical height of 1.1mm
 - Ideal for automated placement
- High temperature soldering guaranteed:260°C/10 seconds at terminals
 Component in accordance to RoHS 2011/65/EU

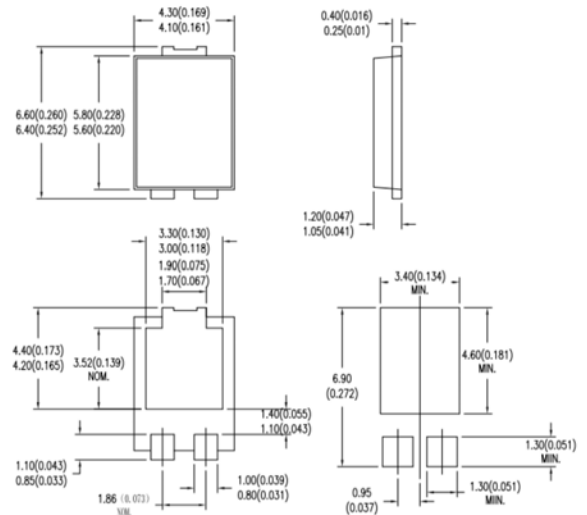


TO-277B



MECHANICAL DATA

- Case: **TO-277B** molded plastic body
- Terminals: Plated axial leads, solderable per MIL-STD-750,method 2026
- Mounting Position: Any
- Weight: 0.092 grams (approx)



TYPICAL APPLICATIONS

For use in low voltage ,high frequency inverters ,DC/DC converters, free wheeling ,and polarity protection applications

MAXIMUM RATINGS

(Ratings at 25°C ambient temperature unless otherwise specified)

Parameter	Symbol	Value	Unit
Maximum repetitive peak reverse voltage	V_{RRM}	150	V
Maximum average forward rectified current	$I_{F(AV)}$	10.0	A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC method at rated TL)	I_{FSM}	120	A
Operating junction temperature range	T_J	-55 to+150	°C
Storage temperature range	T_{stg}	-55 to+150	°C

ELECTRICAL CHARACTERISTICS (T_A=25°C Unless otherwise noted)

Parameter	Test Conditions		Symbol	TYP.	MAX.	Unit
Instaneous forward voltage	I _F =10.0A	T _A =25°C	V _F ¹⁾	0.83	0.90	V
		T _A =100°C		0.71	—	
		T _A =125°C		0.67	—	
	I _F =5.0A	T _A =25°C		0.77	—	
		T _A =100°C		0.65	—	
		T _A =125°C		0.61	—	
Reverse current	V _R =150V	T _A =25°C	I _R ²⁾	5.0	20	μ A
		T _A =100°C		0.3	—	mA
		T _A =125°C		1.5	—	
Typical junction capacitance	4V, 1MHz		C _J	180		pF

Notes: 1.Pulse test: 300 μs pulse width, 1% duty cycle

2.Pulse test: pulse width ≤ 40ms

THERMAL CHARACTERISTICS

Parameter	Symbol	TO-277B	Unit
Typical thermal resistance ³⁾	R _{θJA}	60.0	°C/W
	R _{θJL}	3.0	

3 Units mounted on recommended PCB 1 oz. Pad layout

RATINGS AND CHARACTERISTIC

FIG.1-FORWARD CURRENT DERATING CURVE

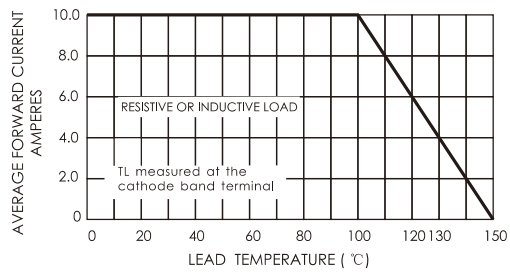


FIG.2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

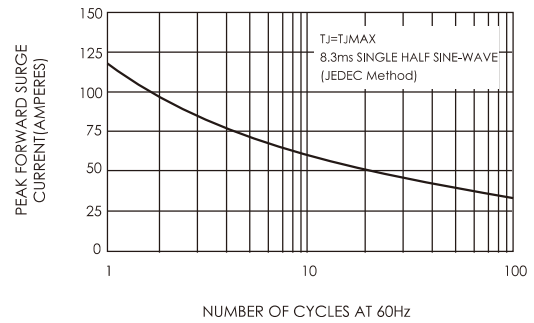


FIG.3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

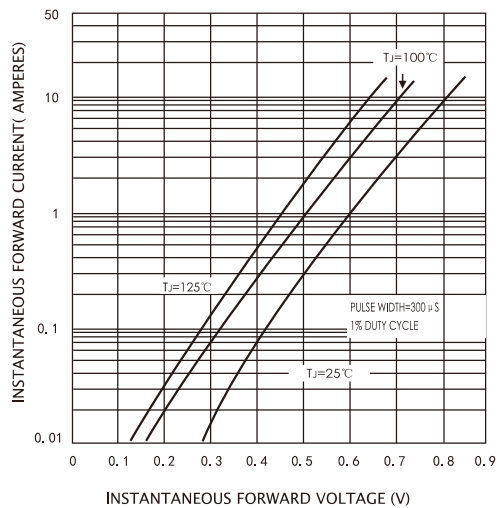


FIG.4-TYPICAL REVERSE CHARACTERISTICS

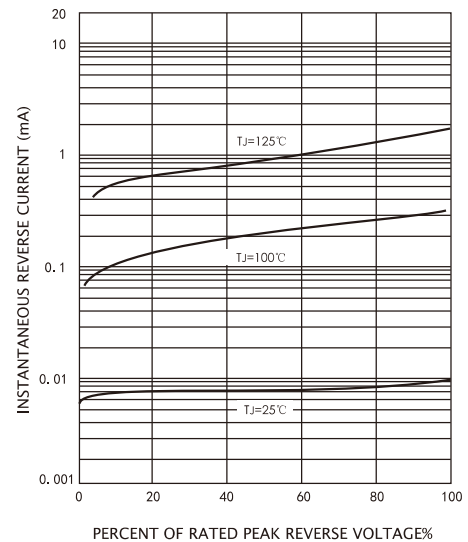


FIG.5-TYPICAL JUNCTION CAPACITANCE

